







STOILOUIT STANDARD REUTECTICS  STOILOUIT LEADFREE BEDUINDERS OF FCL PRODUCT SPECIFICATION 6S-12-192, INCLUDING TELCOROIA CENTRAL OFFICE  NOTES:  (1) MATERIAL: HOUSING: LCP COMMENT COMPER ALLOY HAVE NO SOLDER BALLS OFFICE MAJOR SAPE OF THE STORE STANDARD S	ſ	PRODUCT NUMBER	SOLDER BALL	COMPOSI	ITION	2 	т рі Δ Т	ING PERFORM	3 MANCE LEVEL			4		
SSTOT-2011 STANDARD EUTECTIC)  AJ OVER NI  BOTS:    MATERIAL: HOUSING: LCP   CORTACT: COFPOR ALLOY   PLATING COCKTACT: SEE TABLE,   UL RATING: 94 Y-0.   SOLDER BALLS WILL NOT BE PERFECT   SHPERCAL SHAPE DUE TO REFLOW ATTACHMENT.   SHPERCAL SHAPE DUE TO REFLOW ATTACHMENT.   MAILD HE GRIT LECELD BY CURSION: HS   PROFITE A SCIPIC PACATE.     OCNIACIS IN ROWS A, C.E. G., J., R. H., Z. & AND I ARE SINGLE EDRAW CONTACTS,   TYPICALLY USED AS SIGNAL PINS.    DESCRIPTION OF SCIPICAL SHAPE DUE TO REFLOW PINS.	-	55701-001	STANDARD	(EUTECT)	IC)	CONTACT PLATING PERFORMANCE LEVEL  PERFORMANCE-BASED PLATING, QUALIFIED TO MEET THE REQUIREMENTS OF FCI PRODUCT SPECIFICATION								
NOTES:    MATERIAL:	_	5570I-00ILF												
NOTES:  (I) MATERIAL: HOUSING: LCP CONTACT: COPPER ALLOY PLATING (CONTACT): STE TABLE, J. MATERIAL: SCHEPT ROLL: ISSET INSUE: EMPECTIC SCHEPT ROLL: ISSET INSUE: EMPECTIC SCHEPT ROLL: ISSET INSUE: EMPECTIC SPECIAL SHAPE DUL TO RELION ATTACHMENT.  (I) MATER HEIGHT EFFECTED DY CUSTOMERS' POB PAD SIZE, PLATING, SOLDER REFLOW PROFILE AS SOLDER PASTS.  (I) CONTACTS IN ROWS A.S.E.G.J.K.M.P.R. AND T ARE SHOCLE BEAM CONTACTS, TYPICALLY ISSED AS SROUND PINS. TYPICALLY ISSED AS SOLDEN PASTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS J.B.K. AND THE TOTAL CHARMON PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN ROWS B.D.F.A.L.A.O AND S ARE DUAL GEAM CONTACTS. TYPICALLY USED AS SIGNAD PINS.  (I) CONTACTS IN	A					Au over Ni								
SULDER BALLS (SEE ABLE) LICETIC  SIPPER OR LEADINE 95.5 SIN/Ag/O. SCU  SOLDER BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.  3 MATED HEIGHT EFFECTED BY CUSTOMERS' POB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.  4 CONTACTS IN ROWS A., C., E., G., J., K., M., P., R. AND T. ARE SINGLE BEAM CONTACTS, TYPICALLY USED AS GROUND PINS. (NOTE: CONTACTS IN ROWS J. & K. ARE TIED TOSETHER CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  5 CONTACTS IN ROWS B., P. F., H.L., N.O. AND S. ARE DUAL BEAM CONTACTS, TYPICATION STATEMENT R. POSTICATION FOR CONTACTS AND THE REFERENCE FOR		55701-201LF	NOTES:  MATERIA HOUS CONT PLAT UL F	AL: SING: LCF FACT: COF FING (CON RATING:	PPER ALL NTACT): 94 V-O	SEE TABLE.				DIFPANCE DEFINES	PAN TO PA	n		
APPLICATION SPECIFICATION.  (A) CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T ARE SINGLE BEAM CONTACTS, TYPICALLY USED AS GROUND PINS.  (NOTE: CONTACTS IN ROWS J & K ARE TIED TOGETHER LCOMMONEDDI)  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (S) CONTACTS IN ROWS B,D,F,H,L,N,O AND S ARE DUAL BEAM CONTACTS, TYPICALLY USED AS SIGNAL PINS.  (A) DOTHER WISE SPECIFIED ON EXCOURAGE MAKE THE EUROPEAN UNION DIRECTIVES AND DIRECTIVES AND DIRECTIVE IS DIRECTIVE IN THE LICCOMPANDIAL THE LICCOMPANDIAL THE DIRECTIVE IS DIRECTIVE IS DIRECTIVE IN THE LIC	В	SOLDER BALL: (SEE TABLE) EUTECTIC SINGLE BALLS WILL NOT BE PERFECT SHPERICAL SHAPE DUE TO REFLOW ATTACHMENT.  3 MATED HEIGHT EFFECTED BY CUSTOMERS' PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE & SOLDER PASTE.  4 CONTACTS IN ROWS A,C,E,G,J,K,M,P,R AND T ARE SINGLE BEAM CONTACTS, TYPICALLY USED AS GROUND PINS. (NOTE: CONTACTS IN ROWS J & K ARE TIED TOGETHER [COMMONED])  LOCATION WITHIN LAND PATTERN. POSITIONAL TOLERANCE OF LAND PATTERN. PO FUDICIAL MARKS OR PCB DATUMS SHALL BE DEFINED BY CUSTOMER. FOR PCOMENT. FOR PCOMENT												
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Spec ref   *	yright F													-
TOLERANCES UNLESS OTHERWISE SPECIFIED Chr Alex Cao appr Pei-Ming Zheng appr Pei-Ming Zheng appr Pei-Ming Zheng angular 0° ±2° www.fci.com cat. no. * Product - Customer Drw sheet 5 of 5		'				dr Bill Lin		2010/02/02	projection	mr	Υ			
D OTHERWISE SPECIFIED appr Pei-Ming Zheng 2011/06/27 product family GIG-Array relievel Released rev Surface Inear 0.XX ±0.30 0.XXX ±0.05 FS 570 J Smm RECP. ASSY. 296 SIG. POS. 5570 J Sheet 5 of 5			l T∩LFR	TOLERANCES LINLESS		c h c Alex Can					111111			002042.4
Surface	D	ASME YI	4.5 OTHERW	ISE SPE	CIFIED				product family	GIG	GIG-Array			
		surface	linear	0.XX 0.XXX	±0.10 ±0.05	FCj	-	•	SSY. 296 SIG. P	OS	0 C D M D	55701	11010	rev
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PDS: Rev :J

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